

RD74LVC1G79

Single Positive Edge-triggered D-type Flip Flop

REJ03D0695-0100 Rev.1.00 Feb 23, 2006

Description

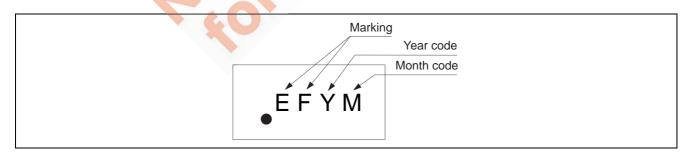
The RD74LVC1G79 has D-type flip flop in a 5-pin package. The input data is transferred to the output at the rising edge of clock pulse CLK. Low voltage and high-speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

Features

- The basic gate function is lined up as Renesas uni logic series.
- Supply voltage range: 1.65 to 5.5 V
- Operating temperature range: -40 to +85°C
- All inputs: V_{IH} (Max.) = 5.5 V (@ V_{CC} = 0 V to 5.5 V)
- All outputs: V_0 (Max.) = 5.5 V (@ V_{CC} = 0 V)
- Output current: $\pm 4 \text{ mA } (@V_{CC} = 1.65 \text{ V})$
 - $\pm 8 \text{ mA} (@V_{CC} = 2.3 \text{ V})$
 - $\pm 24 \text{ mA } (@V_{CC} = 3.0 \text{ V})$
 - $\pm 32 \text{ mA} (@V_{CC} = 4.5 \text{ V})$
- Ordering Information

C				
Part Name	Package Type	Package Code	Package	Taping Abbreviation
		(Previous Code)	Abbreviation	(Quantity)
RD74LVC1G79WPE	WCSP-5 pin	SXBG0005LB-A	WP	E (3,000 pcs/reel)
		(TBS-5CV)		

Article Indication



Function Table

Inp		
CLK	D	Output Q
↑	Н	Н
↑	L	L
L	X	Q_0

H: High level

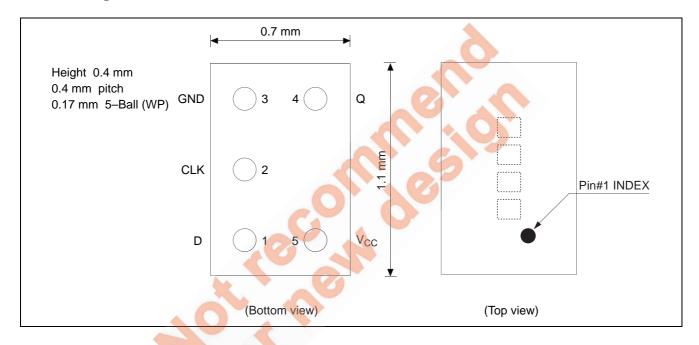
L: Low level

X: Immaterial

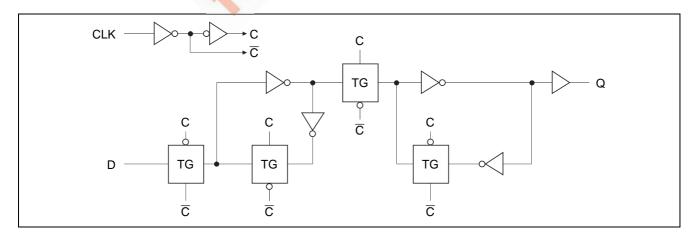
1: Low to high transition

Q₀: Level of Q before the indicated steady input conditions was established.

Pin Arrangement



Logic Diagram



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Test Conditions
Supply voltage range	Vcc	-0.5 to 6.5	V	
Input voltage range *1	VI	-0.5 to 6.5	V	
Output voltage range *1, 2	Vo	-0.5 to V_{CC} +0.5	V	Output: H or L
		-0.5 to 6.5		V _{CC} : OFF
Input clamp current	I _{IK}	– 50	mA	V _I < 0
Output clamp current	I _{OK}	-50	mA	V _O < 0
Continuous output current	Io	±50	mA	$V_O = 0$ to V_{CC}
Continuous current through V _{CC} or GND	I _{CC} or I _{GND}	±100	mA	
Package Thermal impedance	θ_{ja}	200	°C/W	WP
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore no two of which may be realized at the same time.

- 1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
- 2. This value is limited to 5.5 V maximum.

Recommended Operating Conditions

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	Vcc	1.65	5.5	V	
Input voltage range	Vı	0	5.5	V	
Output voltage range	Vo	0	Vcc	V	
Output current	I _{OL}		4	mA	V _{CC} = 1.65 V
		U - (8		V _{CC} = 2.3 V
	100	-	16		V _{CC} = 3.0 V
			24		
		A (-5)	32		V _{CC} = 4.5 V
	I _{OH}		-4	mA	V _{CC} = 1.65 V
	1	_	-8		V _{CC} = 2.3 V
		_	-16		$V_{CC} = 3.0 \text{ V}$
		_	-24		
		_	-32		V _{CC} = 4.5 V
Operating free-air temperature	Ta	-40	85	°C	

Note: Unused or floating inputs must be held high or low.

Electrical Characteristics

Ta = -40 to $85^{\circ}C$

Item	Symbol	V _{CC} (V)	Min	Тур	Max	Unit	Test condition
Input voltage	V _{IH}	1.65 to 1.95	V _{CC} ×0.65	_	_	V	
		2.3 to 2.7	1.7	_	_		
		3.0 to 3.6	2.0	_	_		
		4.5 to 5.5	V _{CC} ×0.7	_	_		
	V _{IL}	1.65 to 1.95		_	V _{CC} ×0.35		
		2.3 to 2.7	_	_	0.7		
		3.0 to 3.6	_	_	0.8		
		4.5 to 5.5	_	_	V _{CC} ×0.3		
Output voltage	V _{OH}	1.65 to 5.5	V _{CC} -0.1	_	_	V	$I_{OH} = -100 \mu A$
		1.65	1.2	_	_		$I_{OH} = -4 \text{ mA}$
		2.3	1.9	_	_		I _{OH} = -8 mA
		3.0	2.4	_	- 🔷		I _{OH} = -16 mA
			2.3	_	- (I _{OH} = -24 mA
		4.5	3.8	_	-		I _{OH} = -32 mA
	V _{OL}	Min to Max	_	_	0.1		I _{OL} = 100 μA
		1.65	_	+	0.45	16	I _{OL} = 4 mA
		2.3	_	-	0.3		I _{OL} = 8 mA
		3.0		1-1	0.4		I _{OL} = 16 mA
					0.55		I _{OL} = 24 mA
		4.5			0.55		I _{OL} = 32 mA
Input current	I _{IN}	0 to 5.5		7	±5	μΑ	$V_{IN} = 5.5 \text{ V or GND}$
Quiescent	Icc	5.5	8	-	10	μΑ	$V_{IN} = V_{CC}$ or GND,
supply current							$I_0 = 0$
	ΔI_{CC}	3 to 5.5		_	500		One input at V _{CC} -0.6 V,
							Other input at V _{CC} or GND
Output leakage	I _{OFF}	0	7	_	±10	μΑ	V_{IN} or $V_O = 0$ to 5.5 V
current							
Input capacitance	CIN	3.3	_	3.5	_	pF	V _{IN} = V _{CC} or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

Switching Characteristics

 $V_{CC} = 1.8 \pm 0.15 \text{ V}$

							FROM	ТО
Item	Symbol	Min	Тур	Max	Unit	Test conditions	(Input)	(Output)
Maximum clock frequency	f _{max}	160	_	_	MHz	C _L = 30 pF		
Propagation delay time	t _{PLH} , t _{PHL}	4.4	_	9.9	ns	C _L = 30 pF	CLK	Q
Setup time	t _{su}	2.2	_	_	ns		D	
Hold time	t _h	0.3	_	_	ns			
Pulse width	t _w	2.5	_	_	ns		CLK "H" or	"L"

 $V_{CC} = 2.5 \pm 0.2 \text{ V}$

							FROM	то
Item	Symbol	Min	Тур	Max	Unit	Test conditions	(Input)	(Output)
Maximum clock frequency	f _{max}	160	_	_	MHz	C _L = 30 pF		
Propagation delay time	t _{PLH} , t _{PHL}	2.3	_	7.0	ns	C _L = 30 pF	CLK	Q
Setup time	t _{su}	1.4	_	_	ns 🗸		D	
Hold time	t _h	0.4	_	_	ns			
Pulse width	t _w	2.5	_	_	ns		CLK "H" or	"L"

 $V_{CC} = 3.3 \pm 0.3 \text{ V}$

							FROM	ТО
Item	Symbol	Min	Тур	Max	Unit	Test conditions	(Input)	(Output)
Maximum clock frequency	f _{max}	160	-		MHz	C _L = 50 pF		
Propagation delay time	t _{PLH} , t _{PHL}	2.0	1	5.0	ns	C _L = 50 pF	CLK	Q
Setup time	t _{su}	1.3	4	_	ns		D	
Hold time	t _h	1.0		4	ns			
Pulse width	t _w	2.5			ns		CLK "H" or	"L"

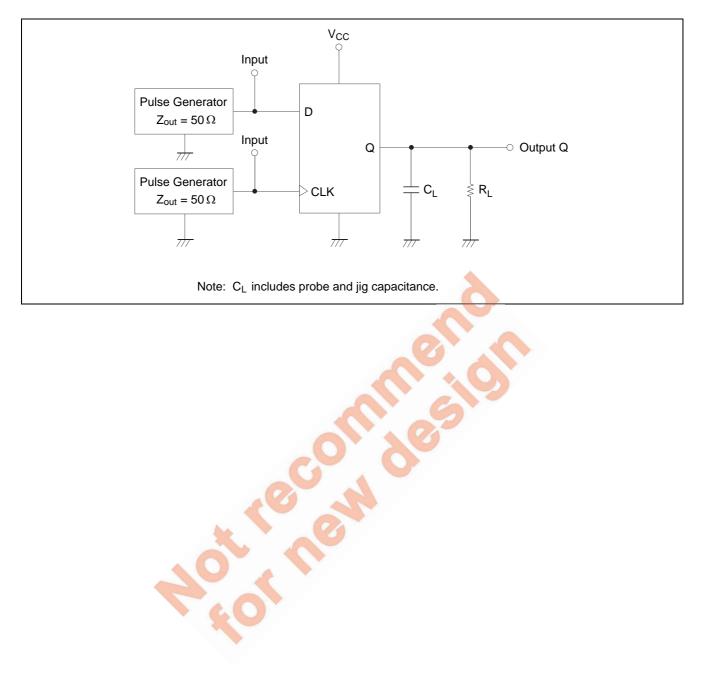
 $V_{CC} = 5.0 \pm 0.5 \text{ V}$

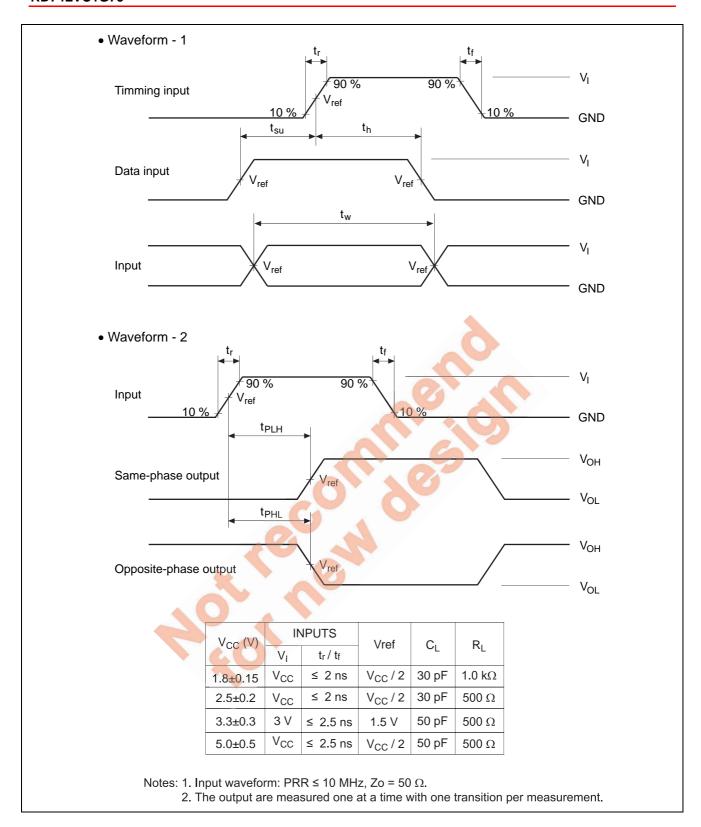
							FROM	ТО
Item	Symbol	Min	Тур	Max	Unit	Test conditions	(Input)	(Output)
Maximum clock frequency	f _{max}	160			MHz	C _L = 50 pF		
Propagation delay time	t _{PLH,} t _{PHL}	1.3		4.5	ns	C _L = 50 pF	CLK	Q
Setup time	t _{su}	1.2		_	ns		D	
Hold time	t _h	0.5			ns			
Pulse width	t _w	2.5	_	_	ns		CLK "H" or	"L"

Operating Characteristics

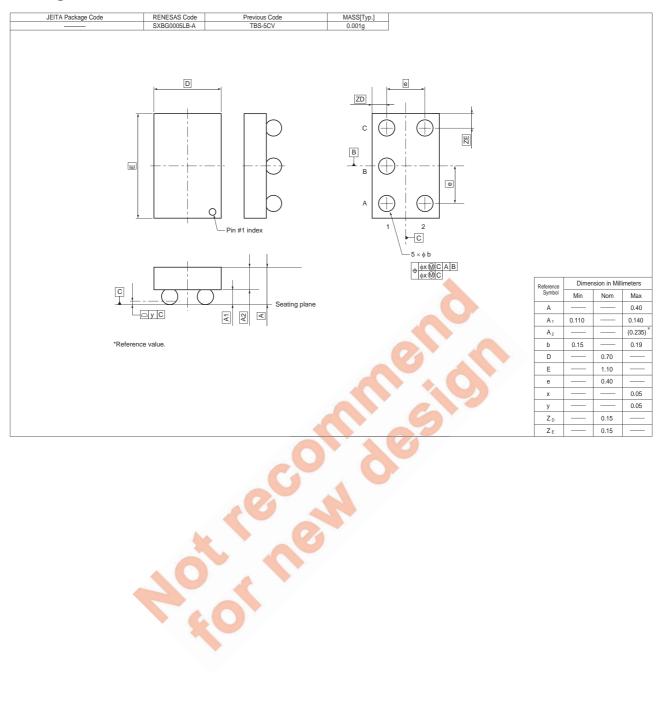
				Ta = 25°C			
Item	Symbol	V _{CC} (V)	Min	Тур	Max	Unit	Test Conditions
Power dissipation capacitance	C _{PD}	1.8	_	20	_	pF	f = 10 MHz
		2.5	_	21	_		
		3.3	_	22	_		
		5.0	_	26	_		

Test Circuit





Package Dimensions



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Renesas Technology Hong Kong Ltd.
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Renesas Technology Malaysia Sdn. Bhd
Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No.18, Jalan Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia Tel: <603> 7955-9390, Fax: <603> 7955-9510

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